



PAL20R8 Family

24-Pin TTL Programmable Array Logic

DISTINCTIVE CHARACTERISTICS

- 5-ns propagation delay
- Popular 24-pin architectures: 20L8, 20R8, 20R6, 20R4
- Programmable replacement for high-speed TTL logic
- Power-up reset for initialization
- Extensive third-party software and programmer support through FusionPLD partners
- 24-pin SKINNYDIP® and 28-pin PLCC packages save space

GENERAL DESCRIPTION

The PAL20R8 Family (PAL20L8, PAL20R8, PAL20R6, PAL20R4) includes the PAL20R8-5 Series which is ideal for high-performance applications. The PAL20R8 Family is provided in the standard 24-pin DIP and 28-pin PLCC pinouts.

The devices provide user programmable logic for replacing conventional SSI/LSI gates and flip-flops at a reduced chip cost.

The family allows the systems engineer to implement the design on-chip, by opening fuse links to configure AND and OR gates within the device, according to the desired logic function. Complex interconnections between gates, which previously required time-consuming layout, are lifted from the PC board and placed on silicon, where they can be easily modified during prototyping or production.

The PAL device implements the familiar Boolean logic transfer function, the sum of products. The PAL device is a programmable AND array driving a fixed OR array. The AND array is programmed to create custom product terms, while the OR array sums selected terms at the outputs.

In addition, the PAL device provides the following options:

- Variable input/output pin ratio
- Programmable three-state outputs
- Registers with feedback

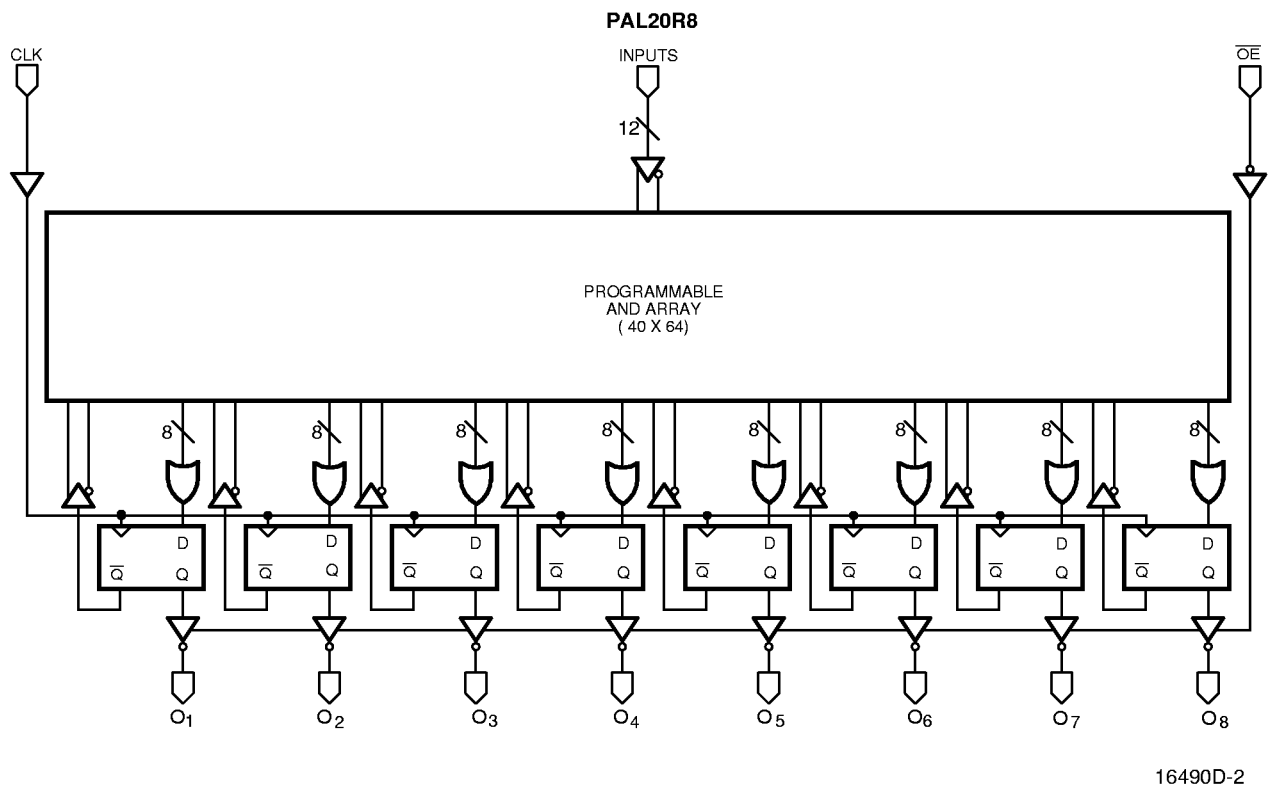
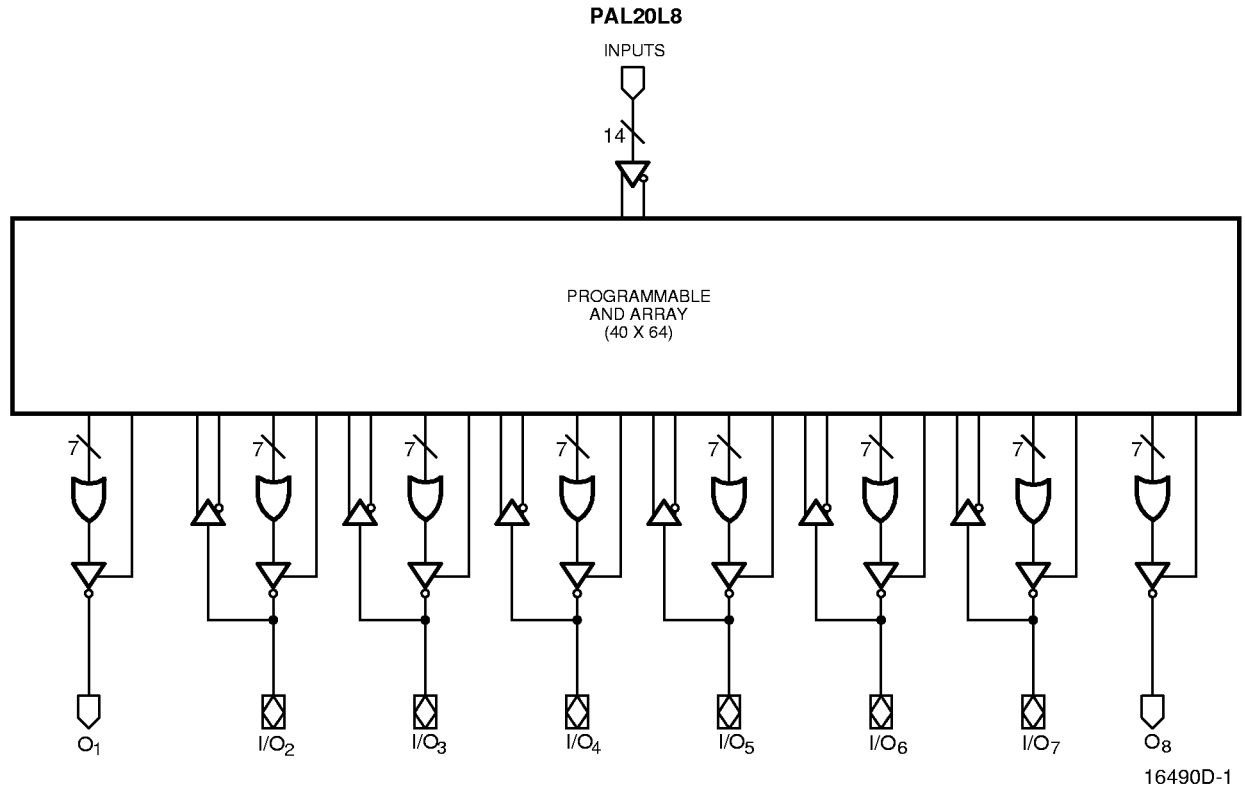
Product terms with all connections opened assume the logical HIGH state; product terms connected to both true and complement of any single input assume the logical LOW state. Registers consist of D-type flip-flops that are loaded on the LOW-to-HIGH transition of the clock. Unused input pins should be tied to V_{CC} or GND.

AMD's FusionPLD program allows PAL20R8 Family designs to be implemented using a wide variety of popular industry-standard design tools. By working closely with the FusionPLD partners, AMD certifies that the tools provide accurate, quality support. By ensuring that third-party tools are available, costs are lowered because a designer does not have to buy a complete set of new tools for each device. The FusionPLD program also greatly reduces design time since a designer can use a tool that is already installed and familiar. Please refer to the PLD Software Reference Guide for certified development systems and the Programmer Reference Guide for approved programmers.

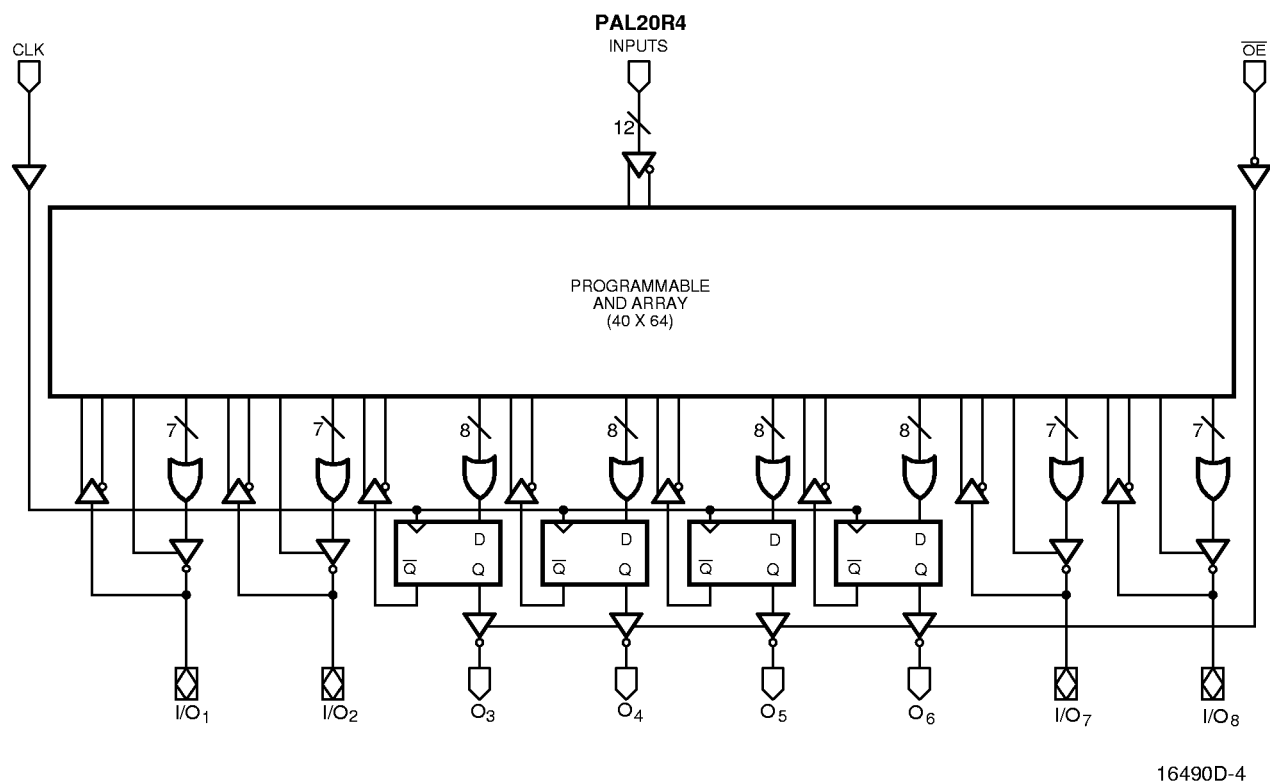
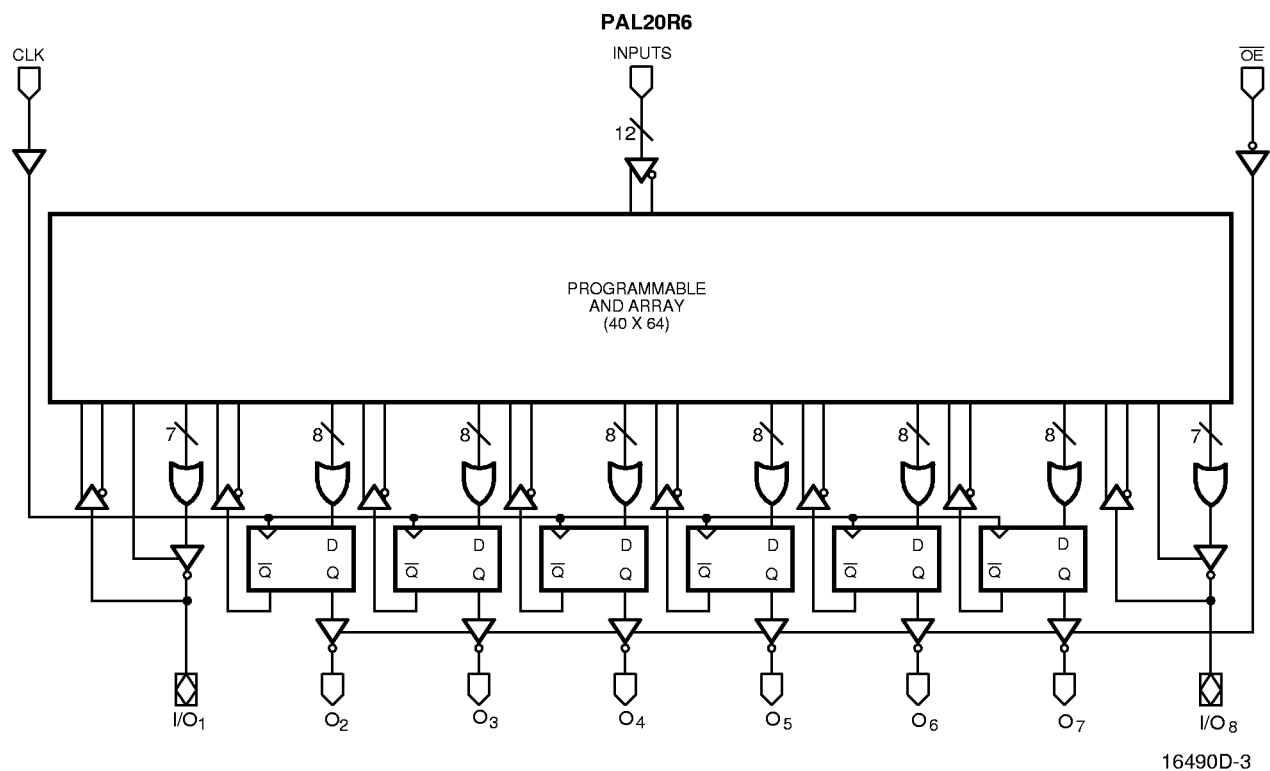
PRODUCT SELECTOR GUIDE

Device	Dedicated Inputs	Outputs	Product Terms/Output	Feedback	Enable
PAL20L8	14	6 comb. I/Os 2 comb. Outputs	7 7	I/O —	prog. prog.
PAL20R8	12	8 reg.	8	reg.	pin
PAL20R6	12	6 reg. 2 comb.	8 7	reg. I/O	pin prog.
PAL20R4	12	4 reg. 4 comb.	8 7	reg. I/O	pin prog.

BLOCK DIAGRAMS



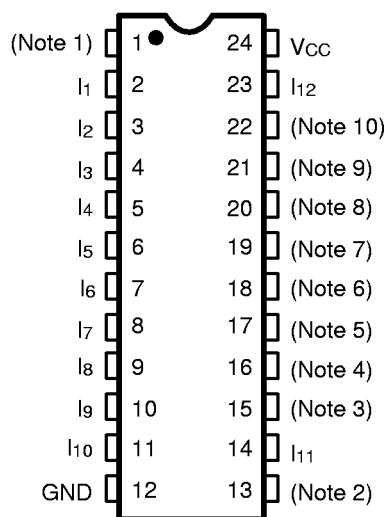
BLOCK DIAGRAMS



CONNECTION DIAGRAMS

Top View

SKINNYDIP/FLATPACK



16490D-5

Note: Pin 1 is marked for orientation.

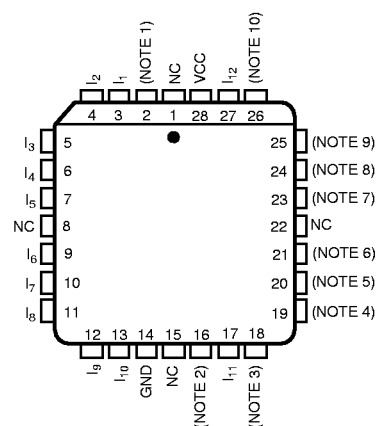
Note	20L8	20R8	20R6	20R4
1	I ₀	CLK	CLK	CLK
2	I ₁₃	$\overline{OE}$	$\overline{OE}$	$\overline{OE}$
3	O ₁	O ₁	I/O ₁	I/O ₁
4	I/O ₂	O ₂	O ₂	I/O ₂
5	I/O ₃	O ₃	O ₃	O ₃
6	I/O ₄	O ₄	O ₄	O ₄
7	I/O ₅	O ₅	O ₅	O ₅
8	I/O ₆	O ₆	O ₆	O ₆
9	I/O ₇	O ₇	O ₇	I/O ₇
10	O ₈	O ₈	I/O ₈	I/O ₈

PIN DESIGNATIONS

CLK	=	Clock
GND	=	Ground
I	=	Input
I/O	=	Input/Output
NC	=	No Connect
O	=	Output
$\overline{OE}$	=	Output Enable
V _{CC}	=	Supply Voltage

PLCC/LCC

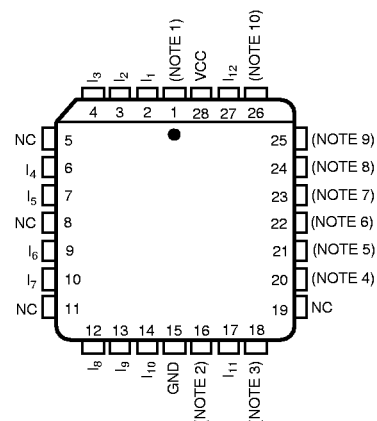
JEDEC: Applies to -5, -7, -10, B-2 Series Only



16490D-6

PLCC

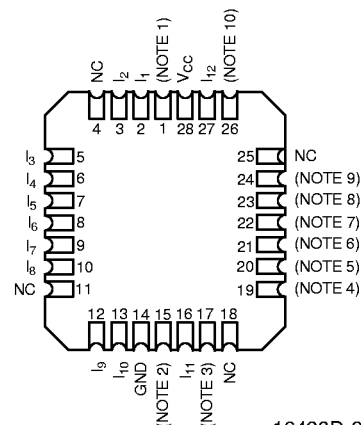
Applies to B and A Series Only



16490D-7

LCC

Applies to B and A Series Only

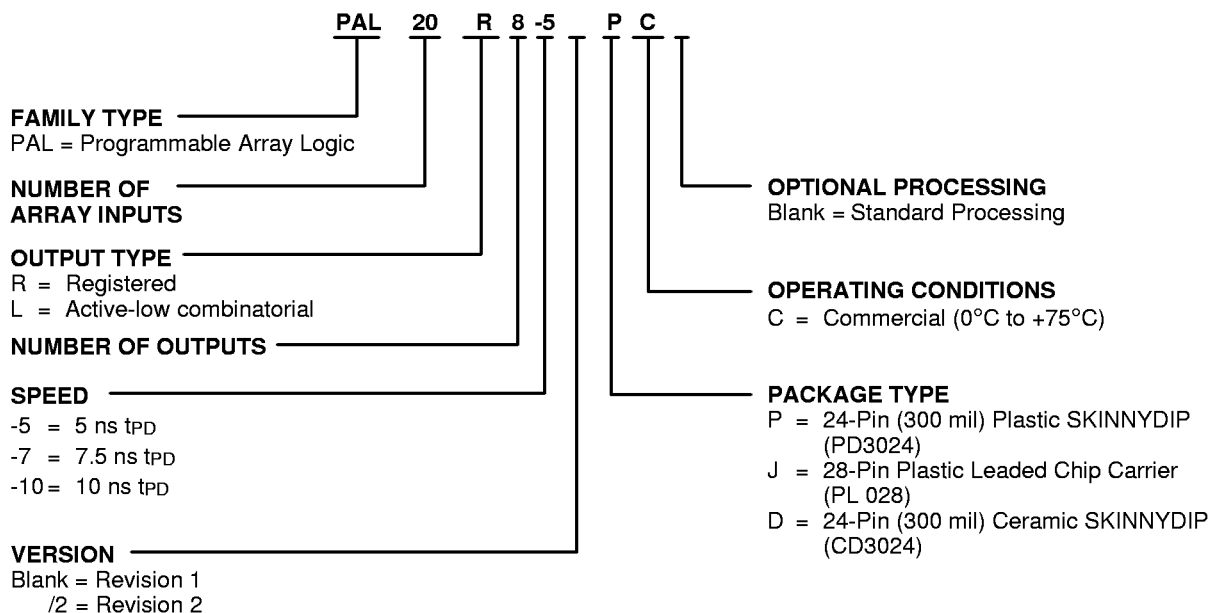


16490D-8

ORDERING INFORMATION

Commercial Products

AMD programmable logic products for commercial applications are available with several ordering options. The order number (Valid Combination) is formed by a combination of:



Valid Combinations	
PAL20L8-5	PC, JC
PAL20R8-5	
PAL20R6-5	
PAL20R4-5	
PAL20L8-10/2	
PAL20R8-10/2	
PAL20R6-10/2	
PAL20R4-10/2	
PAL20L8-7	PC, JC, DC
PAL20R8-7	
PAL20R6-7	
PAL20R4-7	

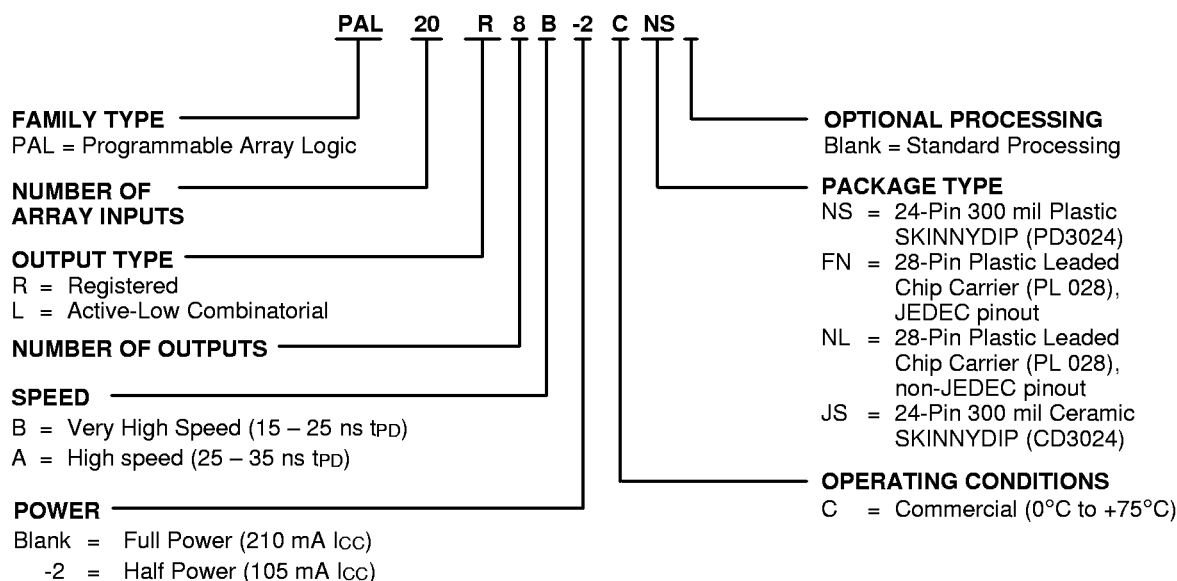
Valid Combinations

Valid Combinations lists configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations and to check on newly released combinations.

ORDERING INFORMATION

Commercial Products (MMI Marking Only)

AMD programmable logic products for commercial applications are available with several ordering options. The order number (Valid Combination) is formed by a combination of:



Valid Combinations		
PAL20L8	B-2	CNS, CFN, CJS
PAL20R8	B, A	CNS, CNL, CJS
PAL20R6		
PAL20R4		

Valid Combinations

Valid Combinations lists configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations and to check on newly released combinations.

Note: Marked with MMI logo.

FUNCTIONAL DESCRIPTION

Standard 24-Pin PAL Family

The standard 24-pin PAL family is comprised of four different devices, including both registered and combinatorial devices. All parts are produced with a fuse link at each input to the AND gate array, and connections may be selectively removed by applying appropriate voltages to the circuit. Using any of a number of development packages, these products can be rapidly programmed to any customized pattern. Extra test words are pre-programmed during manufacturing to ensure extremely high field programming yields, and provide extra test paths to achieve excellent parametric correlation.

Variable Input/Output Pin Ratio

The registered devices have twelve dedicated input lines, and each combinatorial output is an I/O pin. The PAL20L8 has fourteen dedicated input lines, and only six of the eight combinatorial outputs are I/O pins. Buffers for device inputs have complementary outputs to provide user-programmable input signal polarity. Unused input pins should be tied to V_{CC} or GND.

Programmable Three-State Outputs

Each output has a three-state output buffer with three-state control. On combinatorial outputs, a product term controls the buffer, allowing enable and disable to be a function of any product of device inputs or output feedback. The combinatorial output provides a bidirectional I/O pin, and may be configured as a dedicated input if the buffer is always disabled. On registered outputs, an input pin controls the enabling of the three-state outputs.

Registers with Feedback

Registered outputs are provided for data storage and synchronization. Registers are composed of D-type flip-flops that are loaded on the LOW-to-HIGH transition of the clock input.

Power-Up Reset

All flip-flops power-up to a logic LOW for predictable system initialization. Outputs of the PAL20R8 Family will be HIGH due to the active-low outputs. The V_{CC} rise must be monotonic and the reset delay time is 1000 ns maximum.

Register Preload

The register on the AMD marked 20R8, 20R6, and 20R4 devices can be preloaded from the output pins to facilitate functional testing of complex state machine designs. This feature allows direct loading of arbitrary states, making it unnecessary to cycle through long test vector sequences to reach a desired state. In addition, transitions from illegal states can be verified by loading illegal states and observing proper recovery.

Security Fuse

After programming and verification, a PAL20R8 Family design can be secured by programming the security fuse. Once programmed, this fuse defeats readback of the internal programmed pattern by a device programmer, securing proprietary designs from competitors. When the security fuse is programmed, the array will read as if every fuse is intact.

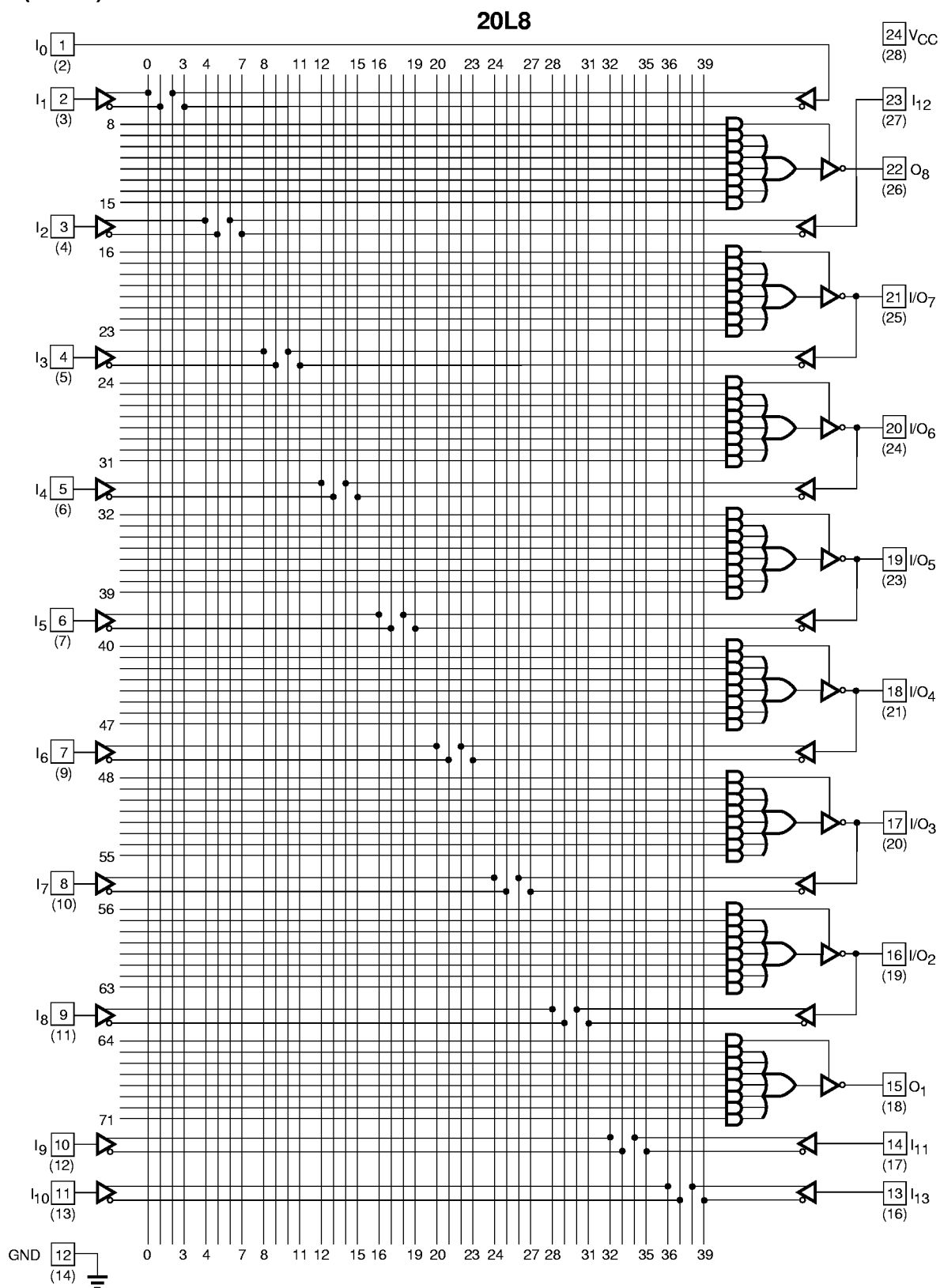
Quality and Testability

The PAL20R8 Family offers a very high level of built-in quality. Extra programmable fuses provide a means of verifying performance of all AC and DC parameters. In addition, this verifies complete programmability and functionality of the device to provide the highest programming yields and post-programming functional yields in the industry.

Technology

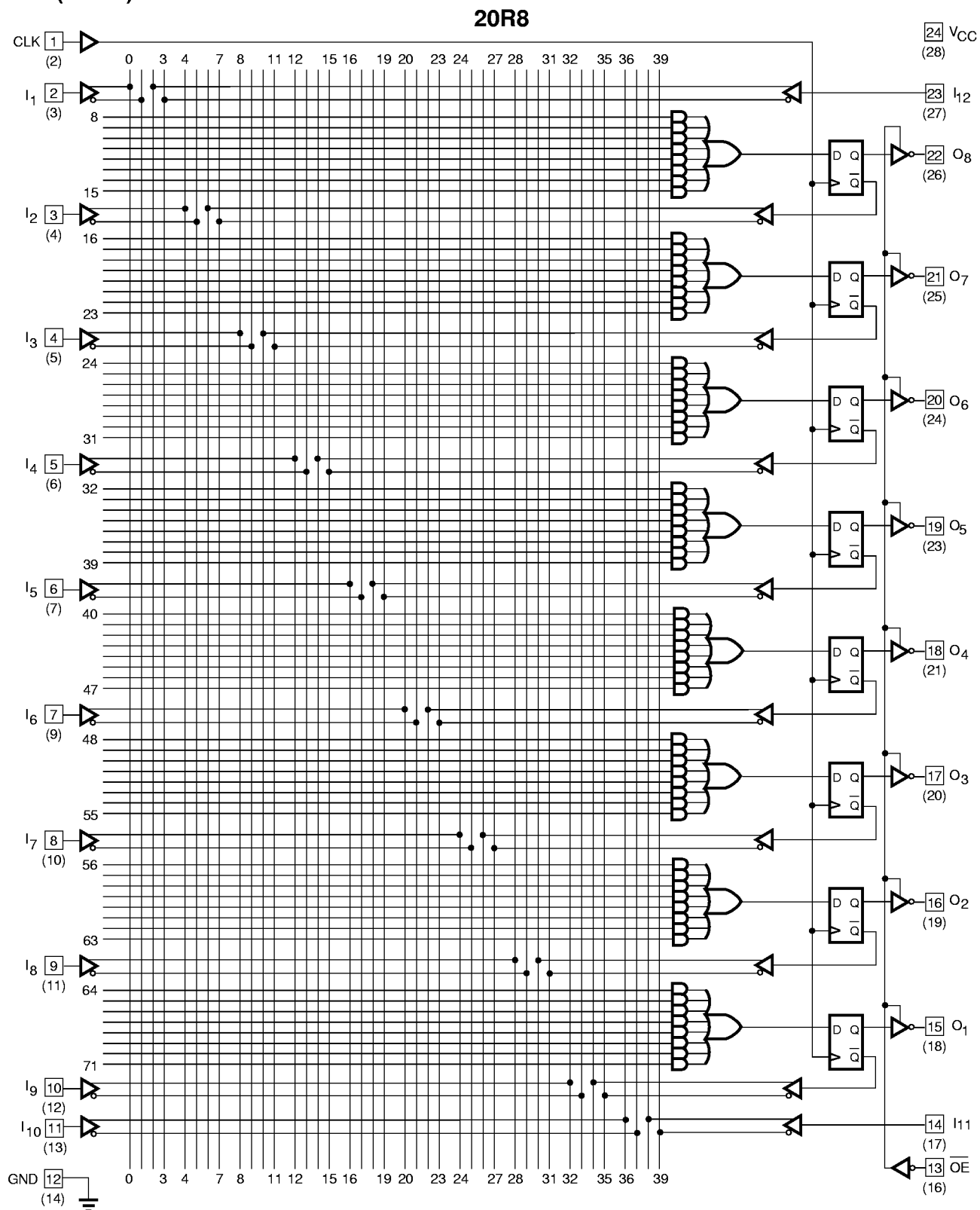
The PAL20R8-5, -7 and 10/2 are fabricated with AMD's oxide isolated process. The array connections are formed with highly reliable PtSi fuses. The PAL20R8B, B-2, and A series are fabricated with AMD's trench-isolated bipolar process. The array connections are formed with proven TiW fuses. These processes reduce parasitic capacitances and minimum geometries to provide higher performance.

LOGIC DIAGRAM DIP (PLCC) Pinouts



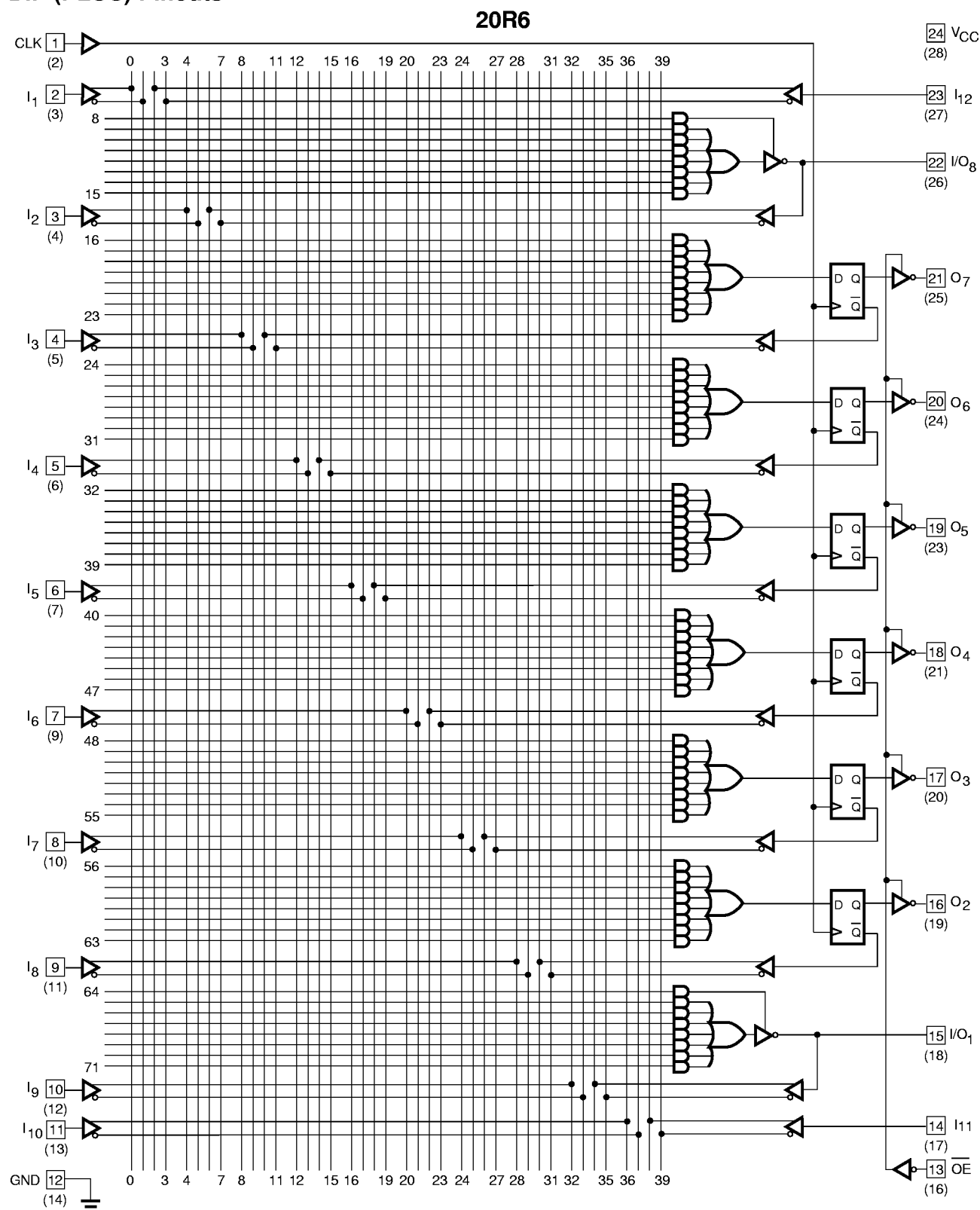
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LOGIC DIAGRAM DIP (PLCC) Pinouts



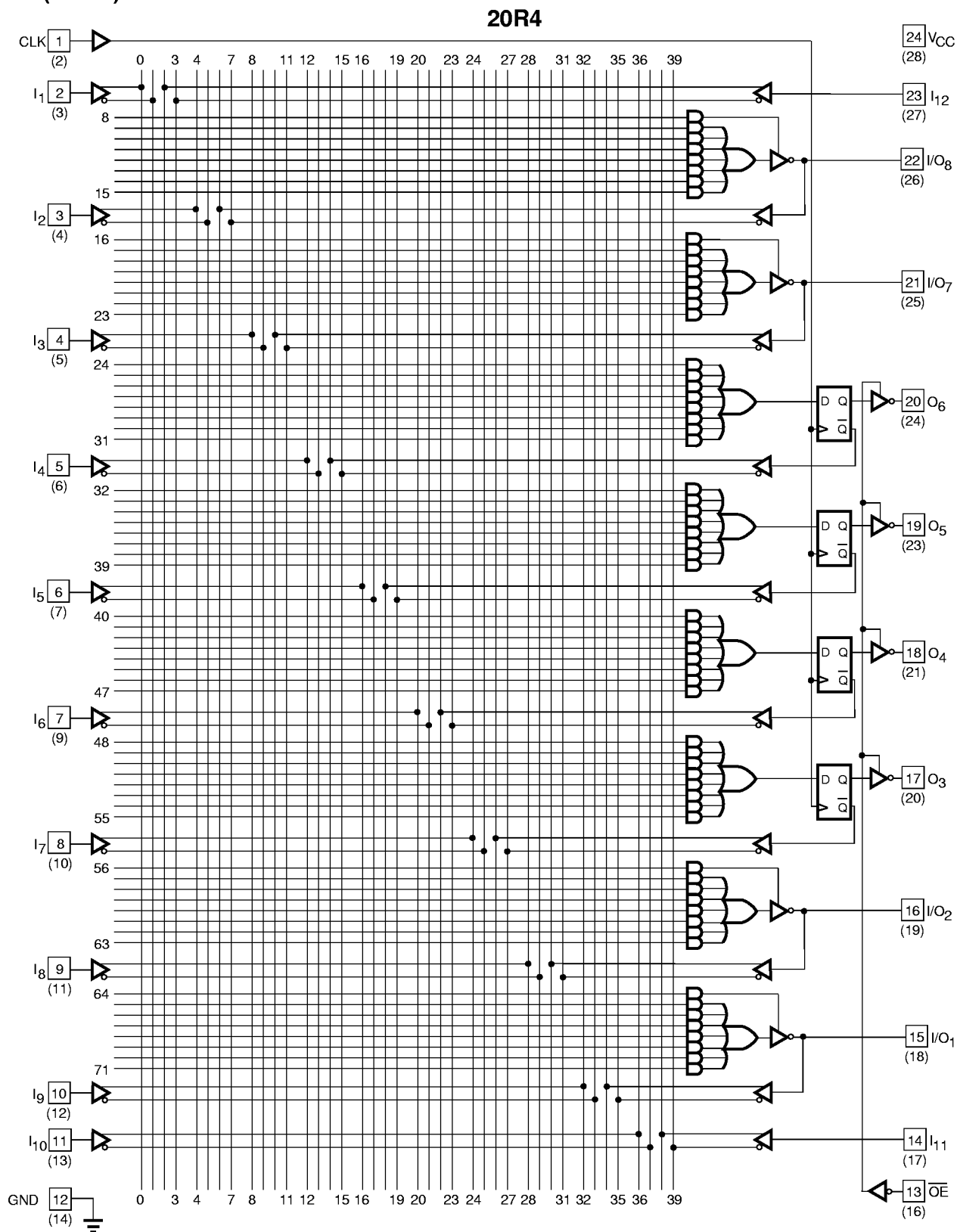
16490D-10

LOGIC DIAGRAM DIP (PLCC) Pinouts



16490D-11

LOGIC DIAGRAM DIP (PLCC) Pinouts



ABSOLUTE MAXIMUM RATINGS

Storage Temperature -65°C to $+150^{\circ}\text{C}$
 Ambient Temperature with
 Power Applied -55°C to $+125^{\circ}\text{C}$
 Supply Voltage with
 Respect to Ground -0.5 V to $+7.0\text{ V}$
 DC Input Voltage -1.2 V to $V_{\text{CC}} + 0.5\text{ V}$
 DC Output or I/O
 Pin Voltage -0.5 V to $V_{\text{CC}} + 0.5\text{ V}$
 Static Discharge Voltage 2001 V

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ.

OPERATING RANGES**Commercial (C) Devices**

Ambient Temperature (T_{A})
 Operating in Free Air 0°C to 75°C
 Supply Voltage (V_{CC})
 with Respect to Ground 4.75 V to 5.25 V

Operating ranges define those limits between which the functionality of the device is guaranteed.

DC CHARACTERISTICS over COMMERCIAL operating ranges unless otherwise specified

Parameter Symbol	Parameter Description	Test Conditions	Min	Max	Unit
V_{OH}	Output HIGH Voltage	$I_{\text{OH}} = -3.2\text{ mA}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} $V_{\text{CC}} = \text{Min}$	2.4		V
V_{OL}	Output LOW Voltage	$I_{\text{OL}} = 24\text{ mA}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} $V_{\text{CC}} = \text{Min}$		0.5	V
V_{IH}	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 1)	2.0		V
V_{IL}	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 1)		0.8	V
V_{I}	Input Clamp Voltage	$I_{\text{IN}} = -18\text{ mA}$, $V_{\text{CC}} = \text{Min}$		-1.2	V
I_{IH}	Input HIGH Current	$V_{\text{IN}} = 2.7\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 2)		25	μA
I_{IL}	Input LOW Current	$V_{\text{IN}} = 0.4\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 2)		-250	μA
I_{I}	Maximum Input Current	$V_{\text{IN}} = 5.5\text{ V}$, $V_{\text{CC}} = \text{Max}$		1	mA
I_{OZH}	Off-State Output Leakage Current HIGH	$V_{\text{OUT}} = 2.7\text{ V}$, $V_{\text{CC}} = \text{Max}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} (Note 2)		100	μA
I_{OZL}	Off-State Output Leakage Current LOW	$V_{\text{OUT}} = 0.4\text{ V}$, $V_{\text{CC}} = \text{Max}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} (Note 2)		-100	μA
I_{SC}	Output Short-Circuit Current	$V_{\text{OUT}} = 0.5\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 3)	-30	-130	mA
I_{CC}	Supply Current	$V_{\text{IN}} = 0\text{ V}$, Outputs Open ($I_{\text{OUT}} = 0\text{ mA}$) $V_{\text{CC}} = \text{Max}$		210	mA

Notes:

- These are absolute values with respect to device ground and all overshoots due to system and/or tester noise are included.
- I/O pin leakage is the worst case of I_{IL} and I_{OZL} (or I_{IH} and I_{OZH}).
- Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second.
 $V_{\text{OUT}} = 0.5\text{ V}$ has been chosen to avoid test problems caused by tester ground degradation.

CAPACITANCE (Note 1)

Parameter Symbol	Parameter Description		Test Conditions		Typ	Unit
C _{IN}	Input Capacitance	CLK, $\overline{OE}$	V _{IN} = 2.0 V	V _{CC} = 5.0 V T _A = +25°C f = 1 MHz	8	pF
		I ₁ – I ₁₂			5	
C _{OUT}	Output Capacitance		V _{OUT} = 2.0 V		8	

Note:

- These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where capacitance may be affected.

SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges (Note 2)

Parameter Symbol	Parameter Description			Min (Note 3)	Max	Unit	
tPD	Input or Feedback to Combinatorial Output			20L8, 20R6, 20R4	1	5	ns
ts	Setup Time from Input or Feedback to Clock			20R8, 20R6, 20R4	4.5		ns
tH	Hold Time				0		ns
tCO	Clock to Output				1	4	ns
tsKEWR	Skew Between Registered Outputs (Note 4)					1	ns
tWL	Clock Width	LOW			4		ns
tWH		HIGH			4		ns
fMAX	Maximum Frequency (Notes 5 and 6)	External Feedback	1/(ts + tco)		117		MHz
		Internal Feedback (fCNT)	1/(ts + tCF)		125		MHz
		No Feedback	1/(twh + tWL)		125		MHz
tPZX	OE to Output Enable				1	6.5	ns
tPXZ	OE to Output Disable				1	5	ns
tEA	Input to Output Enable Using Product Term Control			20L8, 20R6, 20R4	2	6.5	ns
ter	Input to Output Disable Using Product Term Control				2	5	ns

Notes:

- See Switching Test Circuit for test conditions.
- Output delay minimums for t_{PD}, t_{CO}, t_{PZX}, t_{EA} and t_{ER} are defined under best case conditions. Future process improvements may alter these values; therefore, minimum values are recommended for simulation purposes only.
- Skew testing takes into account pattern and switching direction differences between outputs that have equal loading.
- These parameters are not 100% tested, but are calculated at initial characterization and at any time the design is modified where the frequency may be affected.
- t_{CF} is a calculated value and is not guaranteed. t_{CF} can be found using the following equation:

$$t_{CF} = 1/f_{MAX} \text{ (internal feedback)} - t_S$$

ABSOLUTE MAXIMUM RATINGS

Storage Temperature -65°C to $+150^{\circ}\text{C}$
 Ambient Temperature with
 Power Applied -55°C to $+125^{\circ}\text{C}$
 Supply Voltage with
 Respect to Ground -0.5 V to $+7.0\text{ V}$
 DC Input Voltage -1.2 V to $V_{\text{CC}} + 0.5\text{ V}$
 DC Output or I/O
 Pin Voltage -0.5 V to $V_{\text{CC}} + 0.5\text{ V}$
 Static Discharge Voltage 2001 V

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ.

OPERATING RANGES**Commercial (C) Devices**

Ambient Temperature (T_{A})
 Operating in Free Air 0°C to $+75^{\circ}\text{C}$
 Supply Voltage (V_{CC})
 With Respect to Ground $+4.75\text{ V}$ to $+5.25\text{ V}$

Operating ranges define those limits between which the functionality of the device is guaranteed.

DC CHARACTERISTICS over COMMERCIAL operating ranges unless otherwise specified

Parameter Symbol	Parameter Description	Test Conditions	Min	Max	Unit
V_{OH}	Output HIGH Voltage	$I_{\text{OH}} = -3.2\text{ mA}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} $V_{\text{CC}} = \text{Min}$	2.4		V
V_{OL}	Output LOW Voltage	$I_{\text{OL}} = 24\text{ mA}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} $V_{\text{CC}} = \text{Min}$		0.5	V
V_{IH}	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 1)	2.0		V
V_{IL}	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 1)		0.8	V
V_{I}	Input Clamp Voltage	$I_{\text{IN}} = -18\text{ mA}$, $V_{\text{CC}} = \text{Min}$		-1.2	V
I_{IH}	Input HIGH Current	$V_{\text{IN}} = 2.7\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 2)		25	μA
I_{IL}	Input LOW Current	$V_{\text{IN}} = 0.4\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 2)		-250	μA
I_{I}	Maximum Input Current	$V_{\text{IN}} = 5.5\text{ V}$, $V_{\text{CC}} = \text{Max}$		1	mA
I_{ozH}	Off-State Output Leakage Current HIGH	$V_{\text{OUT}} = 2.7\text{ V}$, $V_{\text{CC}} = \text{Max}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} (Note 2)		100	μA
I_{ozL}	Off-State Output Leakage Current LOW	$V_{\text{OUT}} = 0.4\text{ V}$, $V_{\text{CC}} = \text{Max}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} (Note 2)		-100	μA
I_{sc}	Output Short-Circuit Current	$V_{\text{OUT}} = 0.5\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 3)	-30	-130	mA
I_{CC}	Supply Current	$V_{\text{IN}} = 0\text{ V}$, Outputs Open ($I_{\text{OUT}} = 0\text{ mA}$) $V_{\text{CC}} = \text{Max}$		210	mA

Notes:

1. These are absolute values with respect to device ground and all overshoots due to system and/or tester noise are included.
2. I/O pin leakage is the worst case of I_{IL} and I_{ozL} (or I_{IH} and I_{ozH}).
3. Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second. $V_{\text{OUT}} = 0.5\text{ V}$ has been chosen to avoid test problems caused by tester ground degradation.

CAPACITANCE (Note 1)

Parameter Symbol	Parameter Description	Test Conditions		Typ	Unit
C _{IN}	Input Capacitance	V _{IN} = 2.0 V	V _{CC} = 5.0 V T _A = +25°C f = 1 MHz	7	pF
C _{OUT}	Output Capacitance	V _{OUT} = 2.0 V		8	

Note:

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SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges (Note 2)

Parameter Symbol	Parameter Description			Min (Note 3)	Max	Unit
t _{PD}	Input or Feedback to Combinatorial Output		20L8, 20R6,	3	7.5	ns
		1 Output Switching	20R4	3	7	
t _S	Setup Time from Input or Feedback to Clock			7		ns
t _H	Hold Time			0		ns
t _{CO}	Clock to Output			1	6.5	ns
t _{SKEW}	Skew Between Registered Outputs (Note 4)				1	ns
t _{WL}	Clock Width	LOW		5		ns
t _{WH}		HIGH		5		ns
f _{MAX}	Maximum Frequency (Notes 5 and 6)	External Feedback	1/(t _S + t _{CO})	74		MHz
		Internal Feedback (f _{CNT})	1/(t _S + t _{CF})	100		MHz
		No Feedback	1/(t _{WH} + t _{WL})	100		MHz
t _{PD}	OE to Output Enable			1	8	ns
t _{PD}	OE to Output Disable			1	8	ns
t _{EA}	Input to Output Enable Using Product Term Control			3	10	ns
t _{ER}	Input to Output Disable Using Product Term Control			3	10	ns

Notes:

- See Switching Test Circuit for test conditions.
- Output delay minimums for t_{PD}, t_{CO}, t_{PD}, t_{PD}, t_{EA} and t_{ER} are defined under best case conditions. Future process improvements may alter these values; therefore, minimum values are recommended for simulation purposes only.
- Skew is measured with all outputs switching in the same direction.
- These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where the frequency may be affected.
- t_{CF} is a calculated value and is not guaranteed. t_{CF} can be found using the following equation:
t_{CF} = 1/f_{MAX} (internal feedback) – t_S.

ABSOLUTE MAXIMUM RATINGS

Storage Temperature -65°C to $+150^{\circ}\text{C}$
 Ambient Temperature with
 Power Applied -55°C to $+125^{\circ}\text{C}$
 Supply Voltage with
 Respect to Ground -0.5 V to $+7.0\text{ V}$
 DC Input Voltage -0.5 V to $V_{\text{CC}} + 0.5\text{ V}$
 DC Output or I/O Pin Voltage . . . -0.5 V to V_{CC} Max
 DC Input Current -30 mA to 5 mA
 Static Discharge Voltage 2001 V

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ.

OPERATING RANGES

Commercial (C) Devices

Ambient Temperature (T_{A})
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V_{OL}	Output LOW Voltage	$I_{\text{OL}} = 24\text{ mA}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} $V_{\text{CC}} = \text{Min}$		0.5	V
V_{IH}	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 1)	2.0		V
V_{IL}	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 1)		0.8	V
V_{I}	Input Clamp Voltage	$I_{\text{IN}} = -18\text{ mA}$, $V_{\text{CC}} = \text{Min}$		-1.5	V
I_{IH}	Input HIGH Current	$V_{\text{IN}} = 2.4\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 2)		25	μA
I_{IL}	Input LOW Current	$V_{\text{IN}} = 0.4\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 2)		-250	μA
I_{I}	Maximum Input Current	$V_{\text{IN}} = 5.5\text{ V}$, $V_{\text{CC}} = \text{Max}$		100	μA
I_{OZH}	Off-State Output Leakage Current HIGH	$V_{\text{OUT}} = 2.4\text{ V}$, $V_{\text{CC}} = \text{Max}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} (Note 2)		100	μA
I_{OZL}	Off-State Output Leakage Current LOW	$V_{\text{OUT}} = 0.4\text{ V}$, $V_{\text{CC}} = \text{Max}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} (Note 2)		-100	μA
I_{SC}	Output Short-Circuit Current	$V_{\text{OUT}} = 0.5\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 3)	-30	-130	mA
I_{CC}	Supply Current	$V_{\text{IN}} = 0\text{ V}$, Outputs Open ($I_{\text{OUT}} = 0\text{ mA}$) $V_{\text{CC}} = \text{Max}$		210	mA

Notes:

- These are absolute values with respect to device ground and all overshoots due to system and/or tester noise are included.
- I/O pin leakage is the worst case of I_{IL} and I_{OZL} (or I_{IH} and I_{OZH}).
- Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second. $V_{\text{OUT}} = 0.5\text{ V}$ has been chosen to avoid test problems caused by tester ground degradation.

CAPACITANCE (Note 1)

Parameter Symbol	Parameter Description	Test Conditions		Typ	Unit
C _{IN}	Input Capacitance	V _{IN} = 2.0 V	V _{CC} = 5.0 V T _A = 25°C	7	pF
C _{OUT}	Output Capacitance	V _{OUT} = 2.0 V	f = 1 MHz	8	

Note:

- These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where capacitance may be affected.

SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges (Note 2)

Parameter Symbol	Parameter Description			Min (Note 3)	Max	Unit	
tPD	Input or Feedback to Combinatorial Output			20L8, 20R6, 20R4	3	10	ns
ts	Setup Time from Input or Feedback to Clock			20R8, 20R6, 20R4	10		ns
tH	Hold Time				0		ns
tCO	Clock to Output				3	8	ns
twL	Clock Width	LOW			7		ns
twh		HIGH			7		ns
fMAX	Maximum Frequency (Notes 4 and 5)	External Feedback	1/(ts + tco)		55.5		MHz
		Internal Feedback (fCNT)	1/(ts + tCF)		58.8		MHz
		No Feedback	1/(twh + twL)		71.4		MHz
tpZX	OE to Output Enable				2	10	ns
tpXZ	OE to Output Disable				2	10	ns
tEA	Input to Output Enable Using Product Term Control			20L8, 20R6, 20R4	3	10	ns
tER	Input to Output Disable Using Product Term Control				3	10	ns

Notes:

- See Switching Test Circuit for test conditions.
- Output delay minimums for t_{PD}, t_{CO}, t_{PZX}, t_{PXZ}, t_{EA} and t_{ER} are defined under best case conditions. Future process improvements may alter these values; therefore, minimum values are recommended for simulation purposes only.
- These parameters are not 100% tested, but are calculated at initial characterization and at any time the design is modified where the frequency may be affected.
- t_{CF} is a calculated value and is not guaranteed. t_{CF} can be found using the following equation:

$$t_{CF} = 1/f_{MAX} \text{ (internal feedback)} - t_S$$

ABSOLUTE MAXIMUM RATINGS

Storage Temperature -65°C to $+150^{\circ}\text{C}$
 Ambient Temperature with
 Power Applied -55°C to $+125^{\circ}\text{C}$
 Supply Voltage with
 Respect to Ground -0.5 V to $+7.0\text{ V}$
 DC Input Voltage -1.5 V to $V_{\text{CC}} + 0.5\text{ V}$
 DC Output or I/O
 Pin Voltage -0.5 V to $V_{\text{CC}} + 0.5\text{ V}$

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ.

OPERATING RANGES

Commercial (C) Devices

Ambient Temperature (T_{A})
 Operating in Free Air 0°C to $+75^{\circ}\text{C}$
 Supply Voltage (V_{CC})
 with Respect to Ground $+4.75\text{ V}$ to $+5.25\text{ V}$

Operating ranges define those limits between which the functionality of the device is guaranteed.

DC CHARACTERISTICS over COMMERCIAL operating ranges unless otherwise specified

Parameter Symbol	Parameter Description	Test Conditions	Min	Max	Unit
V_{OH}	Output HIGH Voltage	$I_{\text{OH}} = -3.2\text{ mA}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} $V_{\text{CC}} = \text{Min}$	2.4		V
V_{OL}	Output LOW Voltage	$I_{\text{OL}} = 24\text{ mA}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} $V_{\text{CC}} = \text{Min}$		0.5	V
V_{IH}	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 1)	2.0		V
V_{IL}	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 1)		0.8	V
V_{I}	Input Clamp Voltage	$I_{\text{IN}} = -18\text{ mA}$, $V_{\text{CC}} = \text{Min}$		-1.5	V
I_{IH}	Input HIGH Current	$V_{\text{IN}} = 2.7\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 2)		25	μA
I_{IL}	Input LOW Current	$V_{\text{IN}} = 0.4\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 2)		-250	μA
I_{I}	Maximum Input Current	$V_{\text{IN}} = 5.5\text{ V}$, $V_{\text{CC}} = \text{Max}$		100	μA
I_{OZH}	Off-State Output Leakage Current HIGH	$V_{\text{OUT}} = 2.7\text{ V}$, $V_{\text{CC}} = \text{Max}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} (Note 2)		100	μA
I_{OZL}	Off-State Output Leakage Current LOW	$V_{\text{OUT}} = 0.4\text{ V}$, $V_{\text{CC}} = \text{Max}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} (Note 2)		-100	μA
I_{SC}	Output Short-Circuit Current	$V_{\text{OUT}} = 0.5\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 3)	-30	-130	mA
I_{CC}	Supply Current	$V_{\text{IN}} = 0\text{ V}$, Outputs Open ($I_{\text{OUT}} = 0\text{ mA}$) $V_{\text{CC}} = \text{Max}$		210	mA

Notes:

1. These are absolute values with respect to device ground and all overshoots due to system and/or tester noise are included.
2. I/O pin leakage is the worst case of I_{IL} and I_{OZL} (or I_{IH} and I_{OZH}).
3. Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second. $V_{\text{OUT}} = 0.5\text{ V}$ has been chosen to avoid test problems caused by tester ground degradation.

SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges (Note 1)

Parameter Symbol	Parameter Description			Min	Max	Unit	
t _{PD}	Input or Feedback to Combinatorial Output		20L8, 20R6, 20R4		15	ns	
t _S	Setup Time from Input or Feedback to Clock		20R8, 20R6, 20R4	15		ns	
t _H	Hold Time			0		ns	
t _{CO}	Clock to Output or Feedback				12	ns	
t _{WL}	Clock Width	LOW		10		ns	
t _{WH}		HIGH		12		ns	
f _{MAX}	Maximum Frequency (Note 2)	External Feedback		1/(t _S + t _{CO})	37		MHz
		No Feedback		1/(t _{WH} + t _{WL})	45		MHz
t _{PZX}	$\overline{OE}$ to Output Enable				15	ns	
t _{PXZ}	$\overline{OE}$ to Output Disable			12	ns		
t _{EA}	Input to Output Enable Using Product Term Control		20L8, 20R6,		18	ns	
t _{ER}	Input to Output Disable Using Product Term Control		20R4		15	ns	

Notes:

1. See Switching Test Circuit for test conditions.
2. These parameters are not 100% tested, but are calculated at initial characterization and at any time the design is modified where frequency may be affected.

ABSOLUTE MAXIMUM RATINGS

Storage Temperature -65°C to $+150^{\circ}\text{C}$
 Ambient Temperature with
 Power Applied -55°C to $+125^{\circ}\text{C}$
 Supply Voltage with
 Respect to Ground -0.5 V to $+7.0\text{ V}$
 DC Input Voltage -1.5 V to $V_{\text{CC}} + 0.5\text{ V}$
 DC Output or I/O
 Pin Voltage -0.5 V to $V_{\text{CC}} + 0.5\text{ V}$

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ.

OPERATING RANGES**Commercial (C) Devices**

Ambient Temperature (T_{A})
 Operating in Free Air 0°C to $+75^{\circ}\text{C}$
 Supply Voltage (V_{CC})
 with Respect to Ground $+4.75\text{ V}$ to $+5.25\text{ V}$

Operating ranges define those limits between which the functionality of the device is guaranteed.

DC CHARACTERISTICS over COMMERCIAL operating ranges unless otherwise specified

Parameter Symbol	Parameter Description	Test Conditions	Min	Max	Unit
V_{OH}	Output HIGH Voltage	$I_{\text{OH}} = -3.2\text{ mA}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} $V_{\text{CC}} = \text{Min}$	2.4		V
V_{OL}	Output LOW Voltage	$I_{\text{OL}} = 24\text{ mA}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} $V_{\text{CC}} = \text{Min}$		0.5	V
V_{IH}	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 1)	2.0		V
V_{IL}	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 1)		0.8	V
V_{I}	Input Clamp Voltage	$I_{\text{IN}} = -18\text{ mA}$, $V_{\text{CC}} = \text{Min}$		-1.5	V
I_{IH}	Input HIGH Current	$V_{\text{IN}} = 2.7\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 2)		25	μA
I_{IL}	Input LOW Current	$V_{\text{IN}} = 0.4\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 2)		-250	μA
I_{I}	Maximum Input Current	$V_{\text{IN}} = 5.5\text{ V}$, $V_{\text{CC}} = \text{Max}$		100	μA
I_{OZH}	Off-State Output Leakage Current HIGH	$V_{\text{OUT}} = 2.7\text{ V}$, $V_{\text{CC}} = \text{Max}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} (Note 2)		100	μA
I_{OZL}	Off-State Output Leakage Current LOW	$V_{\text{OUT}} = 0.4\text{ V}$, $V_{\text{CC}} = \text{Max}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} (Note 2)		-100	μA
I_{SC}	Output Short-Circuit Current	$V_{\text{OUT}} = 0.5\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 3)	-30	-130	mA
I_{CC}	Supply Current	$V_{\text{IN}} = 0\text{ V}$, Outputs Open ($I_{\text{OUT}} = 0\text{ mA}$) $V_{\text{CC}} = \text{Max}$		105	mA

Notes:

- These are absolute values with respect to device ground and all overshoots due to system and/or tester noise are included.
- I/O pin leakage is the worst case of I_{IL} and I_{OZL} (or I_{IH} and I_{OZH}).
- Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second.
 $V_{\text{OUT}} = 0.5\text{ V}$ has been chosen to avoid test problems caused by tester ground degradation.

SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges (Note 1)

Parameter Symbol	Parameter Description			Min	Max	Unit	
tPD	Input or Feedback to Combinatorial Output		20L8, 20R6, 20R4		25	ns	
ts	Setup Time from Input or Feedback to Clock		20R8, 20R6, 20R4	25		ns	
tH	Hold Time			0		ns	
tCO	Clock to Output				15	ns	
tWL	Clock Width	LOW		15		ns	
tWH		HIGH		15		ns	
fMAX	Maximum Frequency (Notes 3 and 4)	External Feedback		1/(ts + tco)	25		MHz
		Internal Feedback (fCNT)		1/(ts + tCF)	28.5		MHz
		No Feedback		1/(tWH + tWL)	33.3		MHz
tPZX	OE to Output Enable				20	ns	
tPXZ	OE to Output Disable			20	ns		
tEA	Input to Output Enable Using Product Term Control		20L8, 20R6, 20R4		25	ns	
ter	Input to Output Disable Using Product Term Control				25	ns	

Notes:

1. See Switching Test Circuit for test conditions.
2. Calculated from measured f_{MAX} internal.
3. These parameters are not 100% tested, but are calculated at initial characterization and at any time the design is modified where frequency may be affected.
4. t_{CF} is a calculated value and is not guaranteed. t_{CF} can be found using the following equation:

$$t_{CF} = 1/f_{MAX} \text{ (internal feedback)} - t_S$$

ABSOLUTE MAXIMUM RATINGS

Storage Temperature -65°C to $+150^{\circ}\text{C}$
 Ambient Temperature with
 Power Applied -55°C to $+125^{\circ}\text{C}$
 Supply Voltage with
 Respect to Ground -0.5 V to $+7.0\text{ V}$
 DC Input Voltage -1.5 V to $V_{\text{CC}} + 0.5\text{ V}$
 DC Output or I/O
 Pin Voltage -0.5 V to $V_{\text{CC}} + 0.5\text{ V}$

Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to Absolute Maximum Ratings for extended periods may affect device reliability. Programming conditions may differ.

OPERATING RANGES

Commercial (C) Devices

Ambient Temperature (T_{A})
 Operating in Free Air 0°C to $+75^{\circ}\text{C}$
 Supply Voltage (V_{CC})
 with Respect to Ground $+4.75\text{ V}$ to $+5.25\text{ V}$

Operating ranges define those limits between which the functionality of the device is guaranteed.

DC CHARACTERISTICS over COMMERCIAL operating ranges unless otherwise specified

Parameter Symbol	Parameter Description	Test Conditions	Min	Max	Unit
V_{OH}	Output HIGH Voltage	$I_{\text{OH}} = -3.2\text{ mA}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} $V_{\text{CC}} = \text{Min}$	2.4		V
V_{OL}	Output LOW Voltage	$I_{\text{OL}} = 24\text{ mA}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} $V_{\text{CC}} = \text{Min}$		0.5	V
V_{IH}	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs (Note 1)	2.0		V
V_{IL}	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs (Note 1)		0.8	V
V_{I}	Input Clamp Voltage	$I_{\text{IN}} = -18\text{ mA}$, $V_{\text{CC}} = \text{Min}$		-1.5	V
I_{IH}	Input HIGH Current	$V_{\text{IN}} = 2.7\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 2)		25	μA
I_{IL}	Input LOW Current	$V_{\text{IN}} = 0.4\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 2)		-250	μA
I_{I}	Maximum Input Current	$V_{\text{IN}} = 5.5\text{ V}$, $V_{\text{CC}} = \text{Max}$		100	μA
I_{OZH}	Off-State Output Leakage Current HIGH	$V_{\text{OUT}} = 2.7\text{ V}$, $V_{\text{CC}} = \text{Max}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} (Note 2)		100	μA
I_{OZL}	Off-State Output Leakage Current LOW	$V_{\text{OUT}} = 0.4\text{ V}$, $V_{\text{CC}} = \text{Max}$ $V_{\text{IN}} = V_{\text{IH}}$ or V_{IL} (Note 2)		-100	μA
I_{SC}	Output Short-Circuit Current	$V_{\text{OUT}} = 0.5\text{ V}$, $V_{\text{CC}} = \text{Max}$ (Note 3)	-30	-130	mA
I_{CC}	Supply Current	$V_{\text{IN}} = 0\text{ V}$, Outputs Open ($I_{\text{OUT}} = 0\text{ mA}$) $V_{\text{CC}} = \text{Max}$		210	mA

Notes:

1. These are absolute values with respect to device ground and all overshoots due to system and/or tester noise are included.
2. I/O pin leakage is the worst case of I_{IL} and I_{OZL} (or I_{IH} and I_{OZH}).
3. Not more than one output should be tested at a time. Duration of the short-circuit should not exceed one second. $V_{\text{OUT}} = 0.5\text{ V}$ has been chosen to avoid test problems caused by tester ground degradation.

SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges (Note 1)

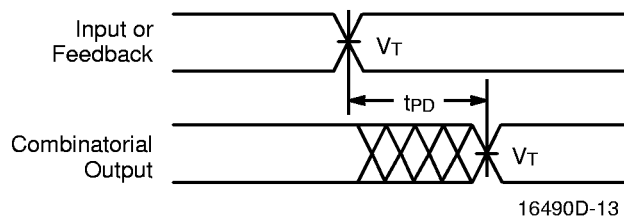
Parameter Symbol	Parameter Description			Min	Max	Unit	
t _{PD}	Input or Feedback to Combinatorial Output			20L8, 20R6, 20R4	25	ns	
t _S	Setup Time from Input or Feedback to Clock			20R8, 20R6, 20R4	25	ns	
t _H	Hold Time				0	ns	
t _{CO}	Clock to Output				15	ns	
t _{WL}	Clock Width	LOW			15	ns	
t _{WH}		HIGH			15	ns	
f _{MAX}	Maximum Frequency (Notes 3 and 4)	External Feedback	1/(t _S + t _{CO})		25	MHz	
		Internal Feedback (f _{CNT})	1/(t _S + t _{CF})		28.5	MHz	
		No Feedback	1/(t _{WH} + t _{WL})		33	MHz	
t _{PZX}	$\overline{OE}$ to Output Enable					20	ns
t _{PXZ}	$\overline{OE}$ to Output Disable					20	ns
t _{EA}	Input to Output Enable Using Product Term Control			20L8, 20R6, 20R4	25	ns	
t _{ER}	Input to Output Disable Using Product Term Control				25	ns	

Notes:

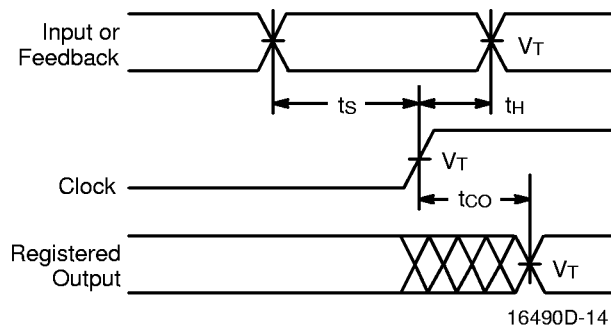
1. See Switching Test Circuit for test conditions.
2. Calculated from measured f_{MAX} internal.
3. These parameters are not 100% tested, but are calculated at initial characterization and at any time the design is modified where frequency may be affected.
4. t_{CF} is a calculated value and is not guaranteed. t_{CF} can be found using the following equation:

$$t_{CF} = 1/f_{MAX} \text{ (internal feedback)} - t_S$$

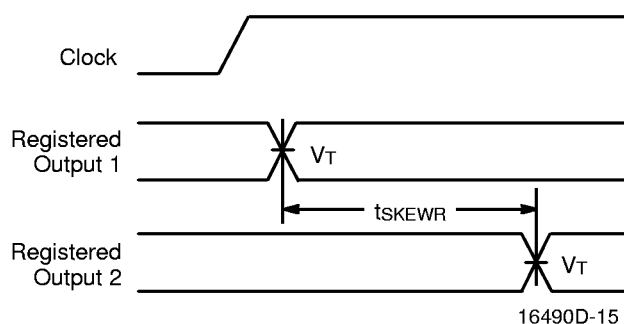
SWITCHING WAVEFORMS



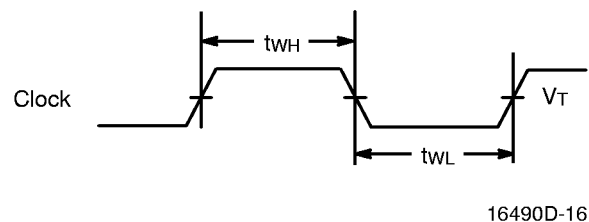
Combinatorial Output



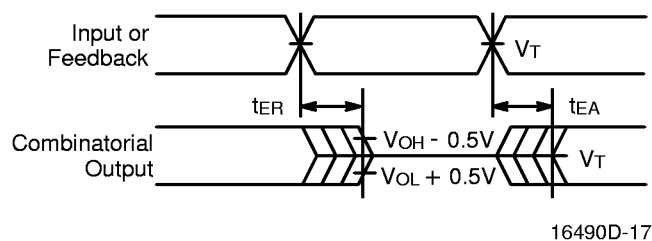
Registered Output



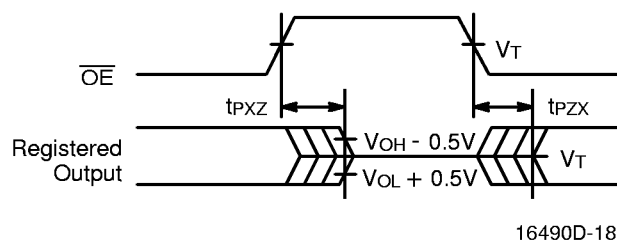
Registered Output Skew



Clock Width



Input to Output Disable/Enable



$\overline{OE}$ to Output Disable/Enable

Notes:

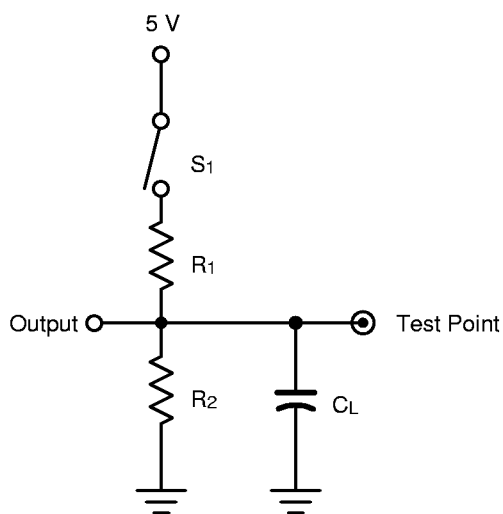
1. $V_T = 1.5\text{ V}$
2. Input pulse amplitude 0 V to 3.0 V
3. Input rise and fall times 2 ns – 3 ns typical

KEY TO SWITCHING WAVEFORMS

WAVEFORM	INPUTS	OUTPUTS
	Must be Steady	Will be Steady
	May Change from H to L	Will be Changing from H to L
	May Change from L to H	Will be Changing from L to H
	Don't Care, Any Change Permitted	Changing, State Unknown
	Does Not Apply	Center Line is High-Impedance "Off" State

KS000010-PAL

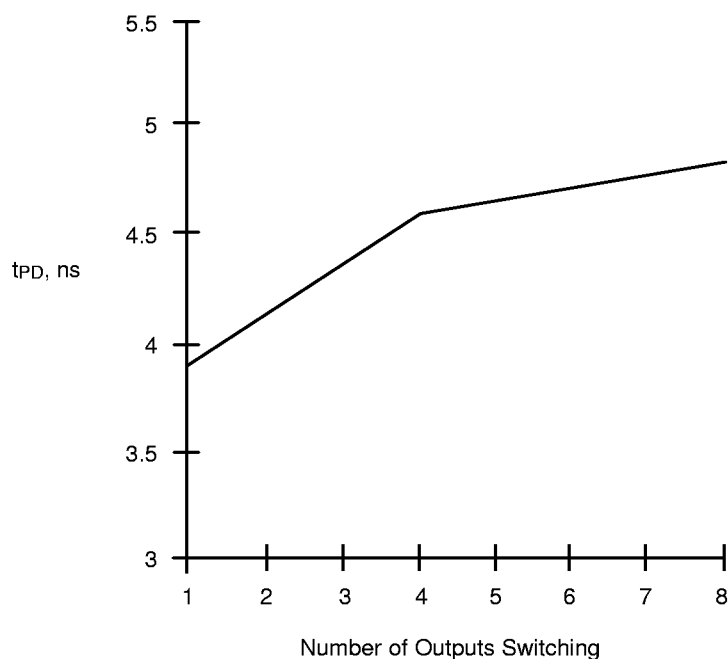
SWITCHING TEST CIRCUIT



16490D-19

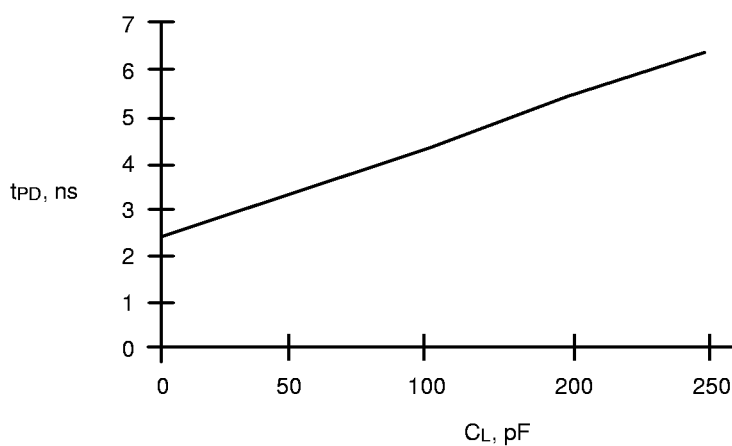
Specification	S ₁	C _L	Commercial		Military		Measured Output Value
			R ₁	R ₂	R ₁	R ₂	
t _{PD} , t _{CO}	Closed	50 pF	200 Ω	For -5: 200 Ω	390 Ω	750 Ω	1.5 V
t _{PZX} , t _{EA}	Z → H: Open Z → L: Closed			For rest 390 Ω			1.5 V
t _{PXZ} , t _{ER}	H → Z: Open L → Z: Closed	5 pF					H → Z: V _{OH} - 0.5 V L → Z: V _{OL} + 0.5 V

MEASURED SWITCHING CHARACTERISTICS FOR THE PAL20R8-5



t_{PD} vs. Number of Outputs Switching
 $V_{CC} = 4.75 \text{ V}$, $T_A = 75^\circ\text{C}$ (Note 1)

16490D-20



t_{PD} vs. Load Capacitance
 $V_{CC} = 5.0 \text{ V}$, $T_A = 25^\circ\text{C}$

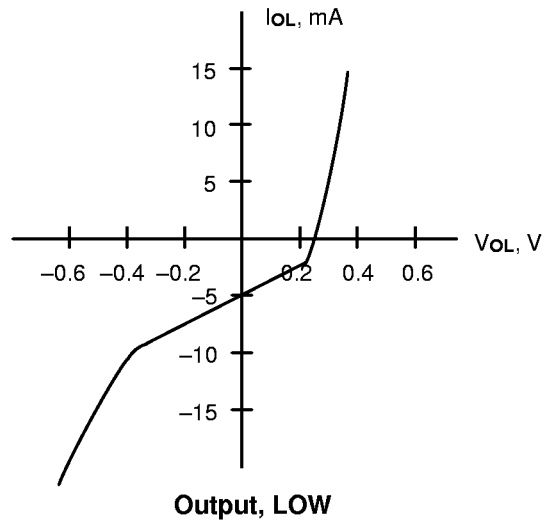
16490D-21

Note:

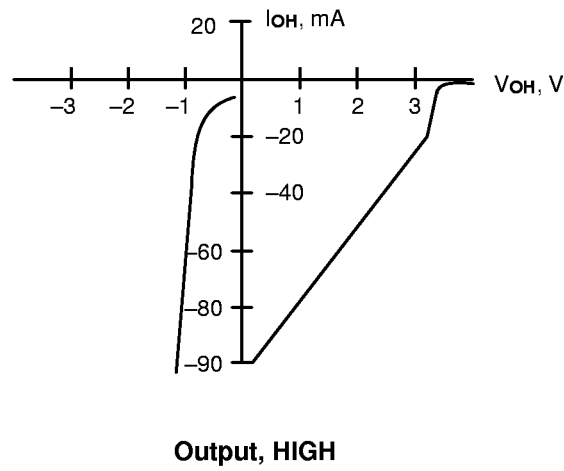
1. These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where t_{PD} may be affected.

CURRENT VS. VOLTAGE (I-V) CHARACTERISTICS FOR THE PAL20R8-5

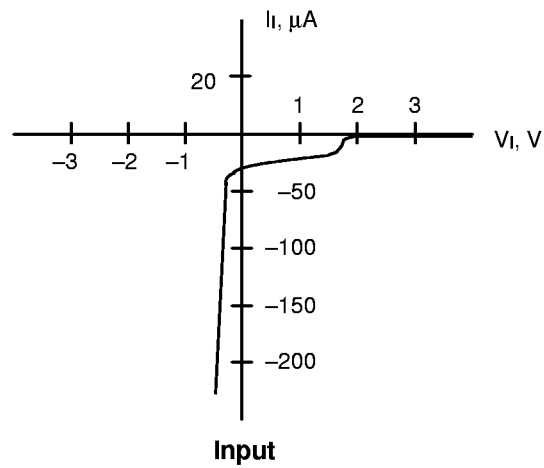
$V_{CC} = 5.0 \text{ V}$, $T_A = 25^\circ\text{C}$



16490D-22

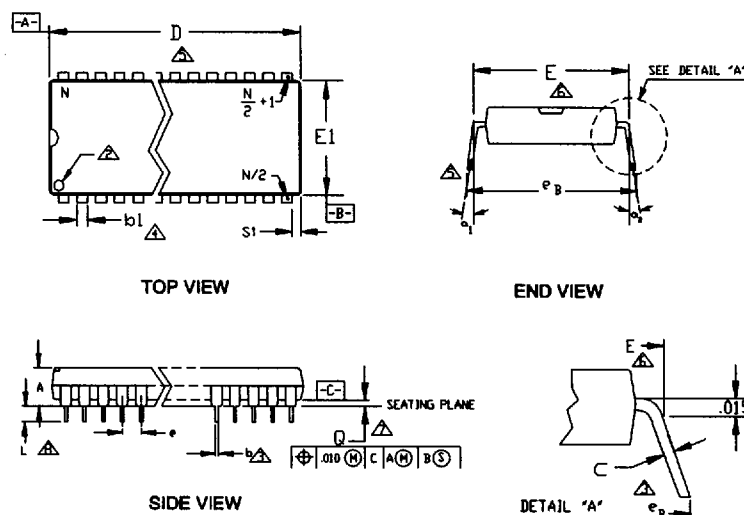


16490D-23



16490D-24

► Plastic Dual In Line (PDIP) Packages



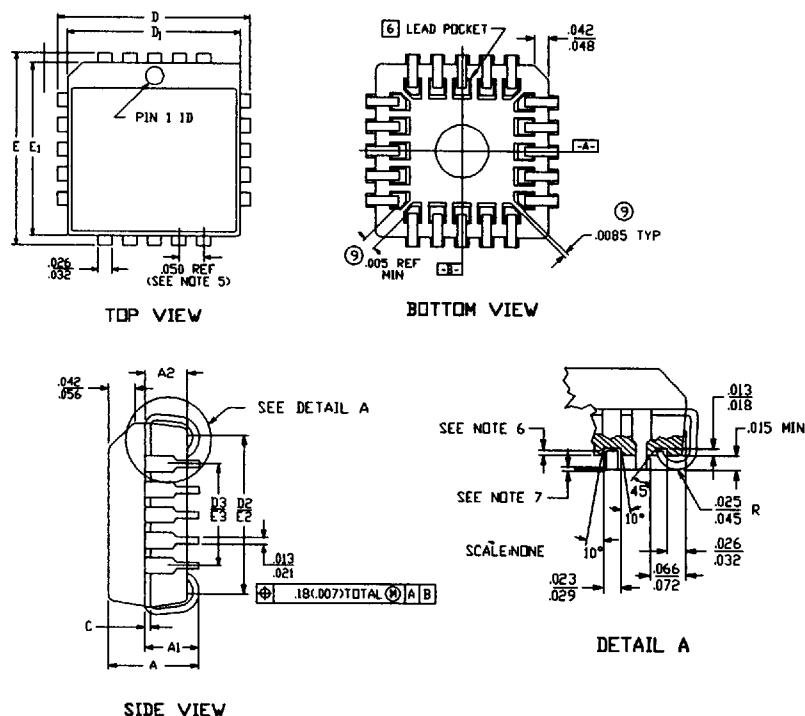
DIMENSION CODES	AMD PACKAGE TYPE & LEADCOUNT (JEDEC DRAWING NUMBER)							
	PD 022		PD 024		PD3024		PDW024	
	(MS-010(C)AA)		(MS-011(B)AA)		(MS-011(B)AA)		(MO-095(A)A8)	
	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX
A	0.140	0.200	0.140	0.225	0.140	0.200	0.140	0.200
b	0.014	0.022	0.014	0.022	0.014	0.022	0.014	0.022
b1	0.045	0.065	0.045	0.065	0.045	0.065	0.045	0.065
C	0.008	0.015	0.008	0.015	0.008	0.015	0.008	0.015
D	1.090	1.120	1.240	1.280	1.150	1.270	1.175	1.220
E1	0.340	0.380	0.520	0.580	0.240	0.280	0.240	0.290
E	0.390	0.430	0.600	0.625	0.300	0.325	0.300	0.330
L	0.120	0.160	0.120	0.160	0.120	0.160	0.120	0.160
e	0.090	0.110	0.090	0.110	0.090	0.110	0.090	0.110
Q	0.015	0.060	0.015	0.060	0.015	0.060	0.015	0.060
S1	0.005	—	0.005	—	0.005	—	0.005	—
e _b	0.430	0.500	0.630	0.700	0.330	0.430	0.330	0.430
($\alpha_1 - \alpha_2$)	0°	10°	0°	10°	0°	10°	0°	10°
(α_1, α_2)	0°	15°	0°	15°	0°	15°	0°	15°
N	22		24		24		24	

Notes:

1. All dimensions are in inches.
2. A notch, tab, or pin one identification mark shall be located adjacent to the device pin one.
3. Lead thickness increases by a maximum of 0.003 inch when a solder lead finish is applied.
4. The minimum limit for the "b1" dimension is 0.030 inch in four corner leads for the PD 016, PD3024, PDW024, PD3028, and PDW028 package versions.
5. Dimensions "D" and "E1" do not include mold flash or protrusion.
6. Dimension "E" is measured from the outside of the leads and 0.015 inch below the plane of the package exit, as defined by the top of the lead.
7. Dimension "Q" is measured from the seating plane to the base plane.
8. Dimension "L" is measured from the seating plane (or from the lowest point of the lead shoulder width that measures 0.040 inch) to the lead tip.
9. The difference between these two dimensions should not exceed seven degrees.
10. When standoff has radii, the seating plane location is defined where the lead width equals 0.040 inch.
11. PD is AMD's internal designator for a plastic dual-in-line package. PD3 and PDW designate PDIP packages with package widths that differ from the standard width for that pin-count size.

► Plastic Leaded Chip Carrier (PLCC) Packages

Square Packages

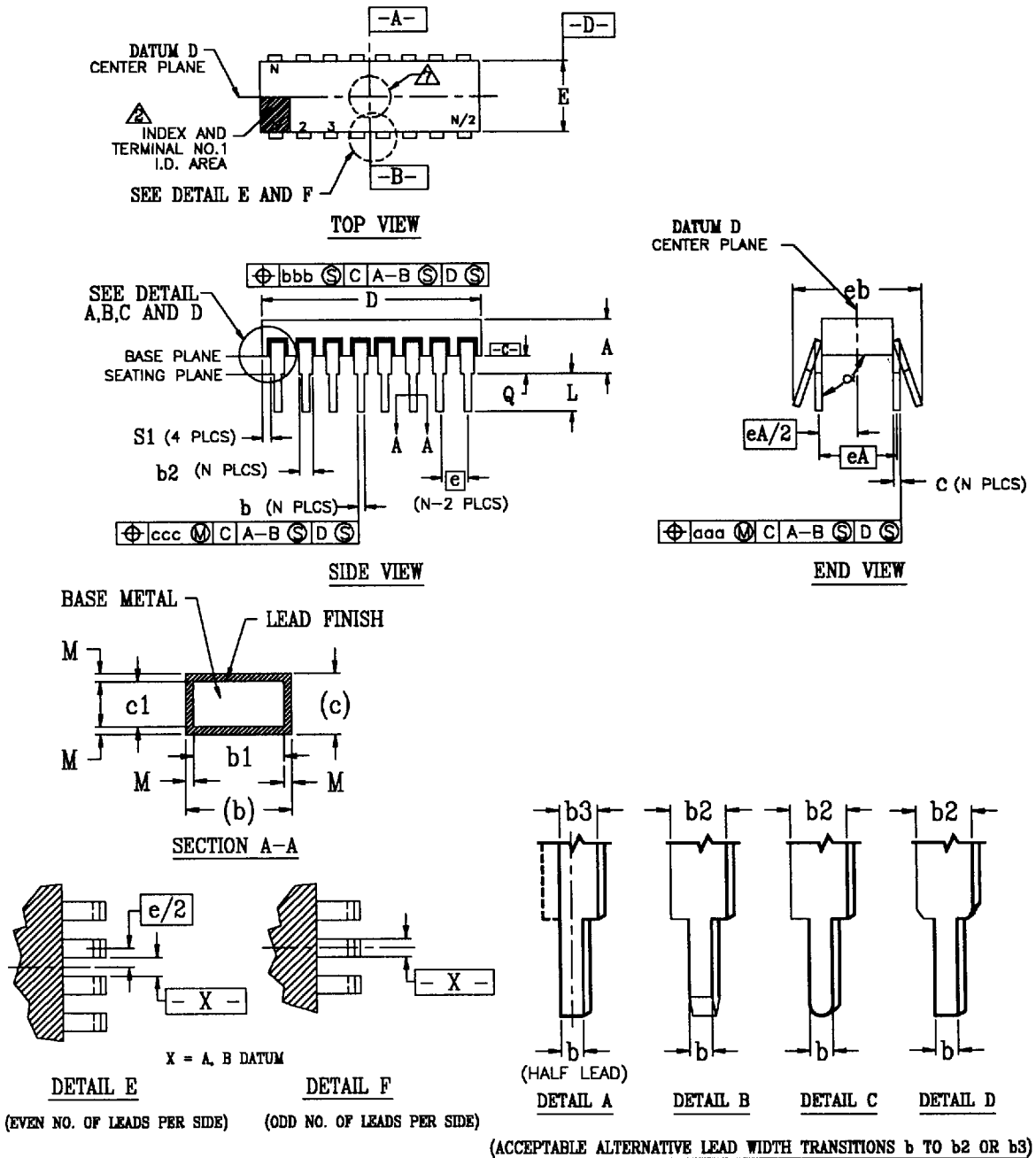


DIMENSION CODES	AMD PACKAGE TYPE & LEADCOUNT (JEDEC DRAWING NUMBER)											
	PL 020		PL 028, PLH028		PL 044		PL 052		PL 068, PLH068		PL 084, PLH084	
	(MS-018(A)AA)		(MS-018(A)AB)		(MS-018(A)AC)		(MO-047(A)AD)		(MO-047(B)AE)		(MO-047(B)AF)	
	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX
A	0.165	0.180	0.165	0.180	0.165	0.180	0.165	0.180	0.165	0.180	0.165	0.180
A1	0.090	0.120	0.090	0.120	0.090	0.120	0.090	0.130	0.090	0.130	0.090	0.130
A2	0.062	0.083	0.062	0.083	0.062	0.083	0.062	0.083	0.062	0.083	0.062	0.083
D, E	0.385	0.395	0.485	0.495	0.685	0.695	0.785	0.795	0.985	0.995	1.185	1.195
D1, E1	0.350	0.356	0.450	0.456	0.650	0.656	0.750	0.756	0.950	0.956	1.150	1.156
D2, E2	0.290	0.330	0.390	0.430	0.590	0.630	0.690	0.730	0.890	0.930	1.090	1.130
D3, E3	0.200 REF		0.300 REF		0.500 REF		0.600 REF		0.800 REF		1.000 REF	
C	0.009	0.015	0.009	0.015	0.009	0.015	0.009	0.015	0.007	0.013	0.007	0.013

Notes:

- All dimensions are in inches.
- Dimensions "D" and "E" are measured from the outermost point.
- Dimensions "D1" and "E1" do not include corner mold flash. Allowable corner mold flash is 0.010 inch.
- Dimensions "A, A1, D2, and E2" are measured from the points of contact to the base plane.
- Lead spacing as measured from the center-line to the center-line shall be within ± 0.005 inch.
- J-bend lead tips should be located inside the "pockets."
- Lead coplanarity shall be within 0.004 inch as measured from the seating plane.
- Lead tweeze shall be within 0.0045 inch on each side as measured from a vertical flat plane.
- The lead pocket may be rectangular (as shown) or oval. If the corner lead pockets are connected, then 0.005-inch minimum lead spacing is required.
- PL is AMD's internal abbreviation for a PLCC. PLH refers to one that has been thermally enhanced with an embedded heat spreader.

► Ceramic Dual In Line (CDIP) Packages



(see table of dimensions on next page)

► Ceramic Dual In Line (CDIP) Packages

DIMENSION CODES	AMD PACKAGE TYPE & LEADCOUNT													
	CD4 022		CD3 024		CD4 024		CD 024		CDE 024		CD4 028		CD028	
	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX
A	0.160	0.220	0.140	0.200	0.160	0.220	0.160	0.220	0.140	0.200	0.160	0.220	0.160	0.220
b	0.014	0.026	0.014	0.026	0.014	0.026	0.014	0.026	0.014	0.026	0.014	0.026	0.014	0.026
b1	0.014	0.023	0.014	0.023	0.014	0.023	0.014	0.023	0.014	0.023	0.014	0.023	0.014	0.023
b2	0.045	0.065	0.045	0.065	0.045	0.065	0.045	0.065	0.045	0.065	0.045	0.065	0.045	0.065
b3	0.023	0.045	0.023	0.045	0.023	0.045	0.023	0.045	0.023	0.045	0.023	0.045	0.023	0.045
C	0.008	0.018	0.008	0.018	0.008	0.018	0.008	0.018	0.008	0.018	0.008	0.018	0.008	0.018
C1	0.008	0.015	0.008	0.015	0.008	0.015	0.008	0.015	0.008	0.015	0.008	0.015	0.008	0.015
D	1.055	1.110	1.235	1.280	1.175	1.230	1.235	1.290	1.235	1.280	1.435	1.490	1.435	1.490
E	0.370	0.405	0.280	0.310	0.370	0.405	0.565	0.605	0.280	0.310	0.370	0.405	0.565	0.605
e	0.100 BASIC		0.100 BASIC		0.100 BASIC		0.100 BASIC		0.100 BASIC		0.100 BASIC		0.100 BASIC	
eA	0.400 BASIC		0.300 BASIC		0.400 BASIC		0.600 BASIC		0.300 BASIC		0.400 BASIC		0.600 BASIC	
eA/2	0.200 BASIC		0.150 BASIC		0.200 BASIC		0.300 BASIC		0.150 BASIC		0.200 BASIC		0.300 BASIC	
eb	—	0.500	—	0.400	—	0.500	—	0.700	—	0.400	—	0.500	—	0.700
L	0.125	0.200	0.125	0.200	0.125	0.200	0.125	0.200	0.125	0.200	0.125	0.200	0.125	0.200
M	—	0.0015	—	0.0015	—	0.0015	—	0.0015	—	0.0015	—	0.0015	—	0.0015
Q	0.015	0.060	0.015	0.060	0.015	0.060	0.015	0.060	0.015	0.060	0.015	0.060	0.015	0.060
S1	0.005	—	0.005	—	0.005	—	0.005	—	0.005	—	0.005	—	0.005	—
aaa	—	0.015	—	0.015	—	0.015	—	0.015	—	0.015	—	0.015	—	0.015
bbb	—	0.030	—	0.030	—	0.030	—	0.030	—	0.030	—	0.030	—	0.030
ccc	—	0.010	—	0.010	—	0.010	—	0.010	—	0.010	—	0.010	—	0.010
α	94°	105°	94°	105°	94°	105°	94°	105°	94°	105°	94°	105°	94°	105°
N	22		24		24		24		24		28		28	
MIL-STD 1835 Case Outline ¹⁰	D-7		D-9		D-11		D-3		D-9		NL		D-10	

Notes:

1. All dimensions are in inches.
2. A notch, tab, or pin-one identification mark shall be located adjacent to pin one within the shaded area.
3. Dimensions "D" and "E" allow for off-center lid meniscus and glass overrun.
4. Dimensions "A" and "Q" are measured from the seating plane when the component is inserted into a 0.0415-inch minimum or 0.043-inch maximum gauge-hole socket. For the CD4 024-pin package, a 0.026-inch (minimum) to 0.028-inch (maximum) gauge should be used.
5. Dimension "L" is measured from the seating plane to the lead tips.
6. For dimension "e," each lead spacing shall be located within ± 0.010 inch of its true position.
7. This area may be a round, square, or rectangular shaped ultraviolet (UV) glass window in ceramic DIP packages for erasable memory products (designated as CDV).
8. Dimension "D" does not include units with bumper tape or clips.
9. CD is AMD's internal designator for a ceramic dual-in-line package. CD3 and CD4 indicate that the package width varies from the standard width for that pin-count. CDV means the package cap has a view window. CDE is a CD3 with a view window.
10. When "NL" is listed as the MIL-STD 1835 reference, the package is not listed in MIL-STD 1835.